



Designation: D4473 – 08 (Reapproved 2021)

Standard Test Method for Plastics: Dynamic Mechanical Properties: Cure Behavior¹

This standard is issued under the fixed designation D4473; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

This standard has been approved for use by agencies of the U.S. Department of Defense.

1. Scope

1.1 This test method covers the use of dynamic-mechanical-oscillation instrumentation for gathering and reporting the thermal advancement of cure behavior of thermosetting resin. It may be used for determining the cure properties of both unsupported resins and resins supported on substrates subjected to various oscillatory deformations.

1.2 This test method is intended to provide a means for determining the cure behavior of supported and unsupported thermosetting resins over a range of temperatures by free vibration as well as resonant and nonresonant forced-vibration techniques, in accordance with Practice D4065. Plots of modulus, tan delta, and damping index as a function of time/temperature are indicative of the thermal advancement or cure characteristics of a resin.

1.3 This test method is valid for a wide range of frequencies, typically from 0.01 to 100 Hz. However, it is strongly recommended that low-frequency test conditions, generally below 1.5 Hz, be utilized as they generally will result in more definitive cure-behavior information.

1.4 This test method is intended for resin/substrate composites that have an uncured effective elastic modulus in shear greater than 0.5 MPa.

1.5 Apparent discrepancies may arise in results obtained under differing experimental conditions. These apparent differences from results observed in another study can usually be reconciled, without changing the observed data, by reporting in full (as described in this test method) the conditions under which the data were obtained.

1.6 Due to possible instrumentation compliance, especially in the compressive mode, the data generated may indicate relative and not necessarily absolute property values.

1.7 Test data obtained by this test method are relevant and appropriate for use in engineering design.

1.8 The values stated in SI units are to be regarded as the standard.

1.9 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety, health, and environmental practices and determine the applicability of regulatory limitations prior to use. Specific precautionary statements are given in Note 5.*

NOTE 1—There is no known ISO equivalent to this standard.

1.10 *This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.*

2. Referenced Documents

2.1 *ASTM Standards:*²

D4000 Classification System for Specifying Plastic Materials

D4065 Practice for Plastics: Dynamic Mechanical Properties: Determination and Report of Procedures

D4092 Terminology for Plastics: Dynamic Mechanical Properties

ASTM/IEEE SI–10 Standard for Use of the International System of Units (SI): The Modern Metric System

3. Terminology

3.1 *Definitions*—For definitions applicable to this test method refer to Terminology D4092.

4. Summary of Test Method

4.1 A known amount of thermosetting liquid resin or resin-impregnated substrate is placed in mechanical oscillation at either a fixed or natural resonant frequency or by free vibration and at either isothermal conditions, with a linear temperature increase or using a time-temperature relation simulating a

¹ This test method is under the jurisdiction of ASTM Committee D20 on Plastics and is the direct responsibility of Subcommittee D20.10 on Mechanical Properties.

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² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

*A Summary of Changes section appears at the end of this standard

processing condition. The elastic or loss modulus, or both, of the composite specimen are measured in shear or compression as a function of time. The point in time when tan delta is maximum, and the elastic modulus levels off after an increase, is calculated as the gel time of the resin under the conditions of the test.

NOTE 2—The particular method for measuring the elastic and loss moduli and tan delta depends upon the individual instrument's operating principles.

5. Significance and Use

5.1 This test method provides a simple means of characterizing the cure behavior of thermosetting resins using very small amounts of material (fewer than 3 to 5 g). The data obtained may be used for quality control, research and development, and establishment of optimum processing conditions.

5.2 Dynamic mechanical testing provides a sensitive method for determining cure characteristics by measuring the elastic and loss moduli as a function of temperature or time, or both. Plots of cure behavior and tan delta of a material versus time provide graphical representation indicative of cure behavior under a specified time-temperature profile.

5.3 This test method can be used to assess the following:

5.3.1 Cure behavior, including rate of cure, gel, and cure time.

5.3.2 Processing behavior, as well as changes as a function of time/temperature.

NOTE 3—The presence of the substrate prevents an absolute measure, but allows relative measures of flow behavior during cure.

5.3.3 The effects of processing treatment.

5.3.4 Relative resin behavioral properties, including cure behavior and damping.

5.3.5 The effects of substrate types on cure.

NOTE 4—Due to the rigidity of a supporting braid, the gel time obtained from dynamic mechanical traces will be longer than actual gel time of the unsupported resin measured at the same frequency. This difference will be greater for composites having greater support-to-polymer rigidity ratios.³

5.3.6 Effects of formulation additives that might affect processability or performance.

5.4 For many materials, there may be a specification that requires the use of this test method, but with some procedural modifications that take precedence when adhering to the specification. Therefore, it is advisable to refer to that material specification before using this test method. Table 1 of Classification System **D4000** lists the ASTM materials standards that currently exist.

6. Interferences

6.1 Since small quantities of resin are used, it is essential that the specimens be representative of the polymeric material being tested.

6.2 The result is a response of the thermal advancement or cure behavior of the resin in combination with any substrate used to support the resin.

7. Apparatus

7.1 The function of the apparatus is to hold a neat (unmodified) resin or uncured supported composite formulation or coated substrate of known volume and dimensions. The material acts as the elastic and dissipative element in a mechanically driven oscillatory shear or dynamic compression system. These dynamic mechanical instruments operate in one or more of the following modes for measuring cure behavior in torsional shear or dynamic compression:

7.1.1 Forced, constant amplitude, fixed frequency,

7.1.2 Forced, constant amplitude, resonant oscillation,

7.1.3 Freely decaying oscillation.

7.2 The apparatus shall consist of the following:

7.2.1 *Test Fixtures*, a choice of the following:

7.2.1.1 *Polished Cone and Plate (Having a Known Cone Angle)*—Usually a 25 or 50-mm diameter cone and plate or parallel plates are recommended for neat resins. Variations of this tooling, such as bottom plates with concentric overflow rims, may be used as necessary.

7.2.1.2 *Parallel Plates*, having either smooth, polished, or serrated surfaces are recommended for neat resins or prepregs having less than 6 % volatiles.

7.2.1.3 *Clamps*—A clamping arrangement that permits gripping of the composite sample.

7.2.2 *Oscillatory Deformation (Strain Device)*—A device for applying a continuous oscillatory deformation (strain) to the specimen. The deformation (strain) may be applied and then released, as in free-vibration devices, or continuously applied, as in forced-vibration devices (see Table 1 of Practice **D4065**).

7.2.3 *Detectors*—A device or devices for determining dependent and independent experimental parameters, such as force (stress or strain), frequency, and temperature. Temperature should be measurable with a precision of $\pm 1^\circ\text{C}$, frequency to $\pm 1\%$, and force to $\pm 1\%$.

7.2.4 *Temperature Controller and Oven*—A device for controlling the temperature, either by heating (in steps or ramps), cooling (in steps or ramps), maintaining a constant specimen environment, or a combination thereof. **Fig. 1** illustrates typical time-temperature profiles. A temperature controller should be sufficiently stable to permit measurement of sample temperature to within 1°C .

7.3 *Nitrogen*, or other inert gas supply for purging purposes.

8. Test Specimens

8.1 The neat resin or the self-supporting composition, or both, should be representative of the polymeric material being tested.

8.2 Due to the various geometries that might be used for dynamic mechanical curing of thermosetting resins/composites, specimen size is not fixed by this test method. Cure rates may be influenced by specimen thickness, so equal volumes of material should be used for any series of comparisons.

8.3 For convenience, low-viscosity neat resins can be studied using a supporting substrate.

³ Hedvat, S., *Polymer Engineering and Science*, Vol 21, No. 3, February 1981.